HP 8710w



Intel Core2 Duo T9300 Processor

(2.50 GHz, 6 MB L2 cache, 800 MHz FSB)

Mobile™ Intel® 965PM Express chipset (800 MHz FSB)

17.0 WUXGA WVA AG 8710p Display (1920 X 1200)

NVIDIA FX 1600M 512MB 8710w Graphics

4096M 667DDR2 2DM 8710 Module

200G 7200RPM FX 8710 Hard Drive

DVD RW DL LS 8710 Drive

1 integrated Smart Card reader, 1 Secure Digital slot

10/100/1000

ethernet 56K V92 MDC 8710 Modem

Intel 802.11a/b/g 8710p Card

Bluetooth 2.0+8710p Module

on board Stereo speakers

Microphone 8

8 Cell 73Whr 8710 Battery

1 type I/II PCMCIA-slot

6 x USB 2.0 ports

IEEE 1394

 $1x\,VGA\,HDMI$ standard, DVI only when docked

headphone/ microphone connection

audio in/out

touchpad & pointing stick & Sec Finger Print reader 3,3 (front) x 39,3 x 27,5 cm

3,3 (front) x 39,3 x 27,5 cm / from 3,4 kg

3 Year Pick up and return warranty standaard (See options for 3 year next business onsite warranty)

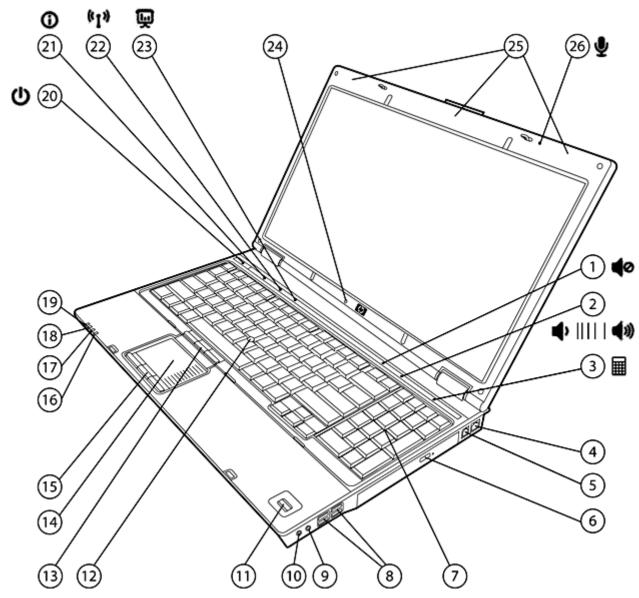
Vista business 32

Inclusief : batterij lader

Overview

HP Compaq 8710w Mobile Workstation

HP recommends Windows Vista® **Business**



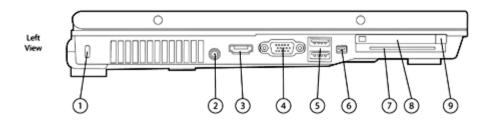
- Volume mute button with LED indicator Volume scroll zone with up/down LED indicators Calculator button

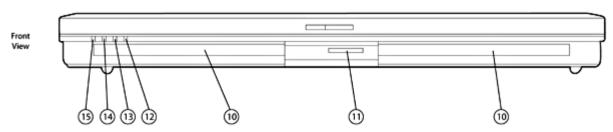
- Calculator button
 RJ-15/Ethernet port
 RJ-11/modem port
 Optical drive
 Full numeric keypad
 4 USB 2.0 ports
 Stereo microphone in
 Stereo headphone/line out
 HP Fingerprint Sensor
 Pointstirk

- Pointstick Pointstick buttons, three

- Touchpad with scroll zone Touchpad buttons, three Hard drive / optical drive activity / HP 3D DriveGuard LED

- 14. 15. 16. 17. 18. 19. 20. 21. 22. 23. 24. 25. 26.
- Hard drive / optical drive activity / HP 3D DriveG Battery charging LED Power/standby LED Wireless on/off LED Power button with LED HP Info / HP QuickLook button with LED indicator Wireless on/off button with LED indicator HP Presentation button with LED indicator Ambient Light Sensor Three WLAN antennas (with WLAN option) Integrated microphone





- Kensington Lock slot
- HDMI port
- VGA/external monitor connector
- 2 USB 2.0 ports
- 1394a port
- Integrated Smart Card Reader
- Type I/II PC Card slot

- PC Card eject button
- Integrated stereo speakers
- 11. Media Card Reader
- 12. Hard drive activity / HP 3D DriveGuard LED
- 13 Battery charging LED
- 14. Power/standby LED
- Wireless on/off LED 15

At A Glance

- NVIDIA Quadro FX 1600M up to $512~\mathrm{MB}$ dedicated memory
- DirectX 10 support and Dual Link DVI (available through optional docking) provides faster rendering capabilities and support for ultra-high resolution monitors
- Intel® Centrino® with vPro $^{\text{TM}}$ technology capable, with Intel Core $^{\text{TM}}2$ Duo processors
- HDMI high definition video/audio port
- DVD+/-RW SuperMulti DL Drive
- Designed to travel, with weight starting at 7.5 lb/3.4 kg and 1.3-inch/33 mm thin at front
- Widescreen 17.0-inch diagonal display with wide-viewing angle and Ambient Light Sensor
- Integrated Media Card Reader
- Full-sized keyboard with separate numeric keypad
- ${\small Enhanced\ reliability\ with\ HP\ DuraKeys,\ HP\ DuraFinish,\ and\ magnesium\ alloy\ support\ structures}$
- Enhanced security features including integrated Smart Card Reader, Drive Encryption for HP ProtectTools, HP Fingerprint Sensor, TPM 1.2**
- HP QuickLook on Windows Vista models for instant access to email, calendar, and contact information
- Flexible wireless connectivity options:
 - Integrated 802.11 a/b/g/draft-n, a/b/g, or b/g wireless LAN module
 - 0 Bluetooth®
- Up to 200-GB 7200 rpm user-removable hard drive with HP 3D DriveGuard protection
- Touch-sensitive controls for HP Info Center, HP QuickLook, wireless on/off, HP Presentation button, volume up, volume down, and mute
- Up to 8GB of 667-MHz DDR2 SDRAM, dual channel memory support
- Integrated Intel Gigabit Network Connection (10/100/1000 NIC)
- Enhanced dual pointing devices (touchpad with scroll zone and pointstick)
- * At initial boot, either 32- or 64-bit can be selected. This is a one time selection and the other version will be deleted ** TPM module disabled where not permitted by law (for example, Russia and China).

Overview Standard Features Options Memory Storage Technical Specifications

Standard Features

Processors

Intel Core 2 Duo Processor T9300 (2.50 GHz, 6 MB L2 cache, 800 MHz FSB)*

* Intel's numbering is not a measurement of higher performance.

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds n battery optimization mode

Operating System

Preinstalled

Genuine Windows Vista Business†*

Supported

Genuine Windows Vista Enterprise* Genuine Windows 2000

Certified

SuSE Linux Enterprise Desktop 10

† At initial boot, either 32- or 64-bit can be selected. This is a one time selection and the other version will be deleted.

* Certain Windows Vista product features require advanced or additional hardware. See https://www.microsoft.com/windowsvista/getready/hardwarereas.mspx and https://www.microsoft.com/windowsvista/getready/hardwarereas.mspx and https://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit https://www.microsoft.com/upgradeadvisor.

Chipse

Mobile Intel PM965 with 800-MHz front side bus

Intel Centrino with vPro technology is a selectable feature that is available on units configured with an Intel Wireless WiFi Link 4965AGN or 4965AG. It provides advances in remote manageability, Intel Centrino with vPro technology capable security, energy efficient performance, and wireless connectivity. Intel Active Management Technology (AMT) offers built-in manageability and proactive security for networked notebook PCs, even wher they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the operating system, isolate infected systems, and update PCs regardless of their power state *Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN. NOTE: Some functionality of Intel Centrino Pro and vPro technology, such as Intel Active Management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Centrino Pro and vPro technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" and Microsoft Windows Vista operating system is yet to be determined. NVIDIA Quadro FX 1600M graphics with 512 MB dedicated video memory Graphics Microsoft DirectX 10 support Display 17.0-inch diagonal WUXGA wide-viewing angle anti-glare (1920 x 1200 resolution) Ambient light sensor Integrated lid switch HP Privacy Filter support Up to 32-bit per pixel color depth External VGA port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz HDMI 1.2 part supports direct connection to high-definition displays with up to 1920 x 1080 resolution and 7-channel audio with one convenient DM port in optional HP Docking Station (sold separately) supports resolutions up to 1920 x 1200 for single-link DVI monitors and up to 2560 x 1600 for dual-link DVI monitors. NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth setting 4096-MB 667-MHz DDR2 SDRAM; two SODIMM slots supporting dual channel memory Memory Upgradeable to 8-GB with 4096-MB SODIMM in slots 1 and 2 Maximum **Dual-channel** Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots. NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Full availability of 8 GB of memory requires Windows Vista Business 64-bit or Linux. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements. Integrated Intel Gigabit Network Connection (10/100/1000 NIC)* Communications 56K V 92 modem** * The term *10/100/1000" or "Gigabit" Ethemet indicates compliance with IEEE standard 802.3ab for Gigabit Ethemet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required ** Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval. Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Wireless LAN is factory configurable or available as an option to be added later. Wireless Devices Integrated Bluetooth is also available (factory configurable only) and can be combined with any of the supported wireless LAN options. All 802.11a/b/g integrated wireless LAN options Wi-Fi certified Cisco Compatible Extensions support (Version 4.0) with Microsoft Windows XP Wired Equivalent Privacy (WEP) support up to 128-bit keys Wi-Fi Protected Access (WPA) and WPA2 support 802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPV2, and LEAP Advanced Encryption Standard (AES) support WiFi certified for WPA2, WMM Three antennas integrated in the display enclosure $\dot{\mbox{\sc display}}$ Intel Wireless WiFi Link 4965AGN Integrated support for 802.11a, b, g, and draft-n Up to 300-mbps data rate HP Integrated Module with Bluetooth Wireless Technology Bluetooth Specification v2.0 compliant Works with a wide range of Bluetooth devices The 101/102-key compatible keyboard features an industry standard, full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and all keys, and 12 function keys. US and International key layouts are available. Other features include a full numeric keypad, holkeys for instant access to power conservation, brightness and other features, 19.05-mm x 19.05-mm key pitch (center-to-center spacing), 3.0-mm stroke, and comfort-dished keycaps. Keyboard HP DuraKeys is a clear coating applied over the notebook keyboard that helps protect the finish and the printed characters on the keys. HP DuraFinish helps protect the finish on the keyboard deck, graphics, and icons from normal wear and tear Touch-sensitive controls Touch-sensitive controls provide easy access to the following features: HP Info Center, HP Quicklook, wireless on/off, HP Presentation button, volume up, volume down, mute, and calculator button Pointina device Enhanced dual pointing devices (touchpad with scroll zone and pointstick, both with three pick buttons) 1 Type I/II PC Card slot Supports 32-bit CardBus and 16-bit PC Cards Expansion card slots

Compatible with ISO 7816 compliant Smart Cards Integrated Smart Card Reader

PC/SC interface support

Secure Digital slot Supports SD (Secure Digital), MMC (MultiMedia Card), Memory Stick, Memory Stick Pro, Memory Stick Duo*, xD-Picture card * Memory Stick Duo Adapters are required and sold separately. Inserting a Memory Stick Duo Card directly into your notebook could damage the memory card and/or notebook

Internal Storage Device 160/200-GB 7200 rpm SMART SATA Hard Drive

NOTE: Hard drives are customer removable and will withstand multiple insertion/removal cycles. Up to 10 GB is reserved for the system recovery software.

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock away from the hard drive. Uses three-axis digital motion HP 3D DriveGuard detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. The digital accelerometer te halts all data transfer and parks the hard drive when abrupt motion is detected.

DVD+/-RW SuperMulti DL LightScribe Drive

Blu-Ray Disc DVD+/-RW SuperMulti DL Drive NOTE: Optical drive is user replaceable with HP option. Requires single screw removal.

PC Card slot One Type I/II PC Card slot

Optical drives

Smart Card Reade One Media Card Reader One External monitor One - VGA 1394a One - 4-pin connector

Stereo microphone in

Stereo headphone/line out One Power connector One RF11/modem One RJ-45/Ethernet One

HDMI One - 1.2 compliant

USB 2.0 Six Docking connector One Secondary battery connector One LED status indicators Sixteer

Audio

High Definition Audio support w/24-bit DAC

Integrated stereo speakers
Integrated microphone
Touch-sensitive controls for volume up, volume down, and mute

Stereo headphone/line out Stereo microphone in

Preinstalled software with Windows Vista or Windows XP

PDF Complete HP Backup and Recovery Manager
HP Help and Support Center
HP QuickLook (Windows Vista only)
HP OpenView Radia Management Agent

HP Performance Tuning Fram HP Universal Print Driver HP ProtectTools Security Manager BIOS Configuration for HP ProtectTools Credential Manager for HP ProtectTools Device Access Manager for HP ProtectTools Drive Encryption for HP ProtectTools Embedded Security for HP ProtectTools

HP Quick Launch Buttons

The Wireless Assistant
Microsoft Office Ready with 60-day Office Professional 2007 Trial Edition (select models)
Roxio Creator 9 (for optional DVD+/-RW and DVD/CDRW drives)

Synaptics Touchpad Driver Symantec Norton Internet Security with complimentary 60-day live update

Intervideo WinDVD - DVD/Blu-Ray Disc Playe Roxio Creator 9 (for optional Blu-Ray Disc drives)

Software provided on disc Additional software available from the web

HP Client Manager Java Card Security for HP ProtectTools

Workstation ISV Certifications

MCAD

(Mechanical CAD/Architectural Engineering and Construction)

AutoDesk AutoCAD AutoDesk Inventor AutoDesk Revit Bentley Microstation Dassault Catia V5 UGS I-DEAS NX 10

UGS I-DEAS NX 11 UGS/PLM Unigraphics NX, NX2, NX3 PTC Pro/E 2001 Mechanica PTC Pro/E Wildfire Mechanica MSC.Patran

UGS Solidedge Solidworks ICEM Surf

CoCreate OneSpace Designer SensAble PTC DV Mockup

Discreet 3DS MAX/Combustion DCC (Digital Content Creation)

Alias Maya Alias Studio Tools Avid Softlmage XSI/3D Avid Express Pro Adobe Premiere/After Effects

ESRI ArcGIS 9

GIS (Geographic Information Systems)

Oil and Gas

SMT

Landmark/GeoGrpahix EDS

Schlumberger/Petrel

HP Performance Tuning Framework

HP Performance Tuning Framework (PTF) enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP PTF will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

HP Backup and Recovery Manager

Each unit is shipped with HP Backup and Recovery Manager. HP Backup and Recovery Manager can provide data and system file protection for HP business PCs to enable fast recovery if the system becomes corrupted or if important information is accidentally deleted. HP Backup and Recovery Manager can perform scheduled or manual backups of the entire drive or individual files and folders. In OGB of the hard drive is reserved for the system recovery software. HP Backup and Recovery Manager can also create software recovery CDs or DVDs (requires optional CD-RW or DVD+/-RW) lders. Up to

SMBIOS Version 2.4

System Management BIOS, previously known as DMI BIOS, is used to store system management information

HP ProtectTools Security Manager

HP ProtectTools Security Manager is the security platform for business notebooks and desktops. The HP ProtectTools Security Manager is an extensible client security console that delivers enhanced security capabilities through add-on software modules. Modules currently available are:

- BIOS Configuration for HP ProtectTools
- Credential Manager for HP ProtectTools
- Device Access Manager for HP ProtectTools
- Drive Encryption for HP ProtectTools
- Embedded Security for HP ProtectTools
- Java Card Security for HP ProtectTools

Security

Standard Features

HP ProtectTools Security Manager

Integrated Smart Card Reader Configuration Control Hardware Memory Change Alert Setup Password Power-On Password TPM 1.2 Embedded Security Chip* TPM Enhanced DriveLock* HP Disk Sanitizer

HP 3D DriveGuard Kensington Lock Slot

Support for Computrace / LoJack for Laptops (must be purchased separately) HP Privacy Filter

Narrows viewing area so that screen data is visible only to persons directly in front of the monitor

* TPM module disabled where use is restricted by law; for example, Russia and China. For more information on HP security solutions refer to http://www.hp.com/go/security.

Power Supply

External 120-wait Smart AC adapter, 6-foot (1.8-meter) power cord included.

External 135-wait Smart AC adapter, 6-foot (1.8-meter) power cord included (required to support NVIDIA FX 3600M graphics)
Total length including external AC adapter is 12 feet (3.66 meter).

HP Fast Charge

Optional Features

*HP Fast Charge recharges your battery up to 90% within 90 minutes when the system is off. HP Fast Charge does not apply to 12-cell Ultra-Capacity batteries.

8-cell (73 WHr) Lithium-Ion battery Primary battery Optional HP Extended Life Battery 8-cell (52 WHr) high capacity Lithium-Ion battery Optional HP Ultra-Capacity Battery 12-cell (95 WHr) high capacity Lithium-Ion battery

Primary battery Up to 4 hours Battery Life Up to 7 hours

Primary battery and optional HP Extended Life Battery

Primary battery and optional HP Ultra-Capacity Battery

Up to 9 hours

NOTE: The listed battery life measurements were taken on models running Microsoft Windows XP Professional. Battery life will vary depending on the product configuration, product model, applications loaded on the product, power management settings of the product, and the product features used by the customer. As with all batteries, the maximum capacity of this battery will decrease with time and usage.

System Standby Time Up to 2 weeks

NVIDIA PowerMizer 7.0 technology Power Conservation

> Hibernation Standby ACPI compliance

Docking and Stands HP Advanced Docking Station

HP Docking Station HP Standard Monitor Stand HP Adjustable Notebook Stand HP External MultiBay II

HP's shared docking solutions provide simple and convenient port replication and cable management. Features include Gigabit NIC pass through, modem pass through, legacy parallel and serial ports, S-video TV out, composite video, Dual Link DVI-D, USB 2.0 ports, integrated security mechanism*, integrated MultiBay II and ExpressCard** slots. These docking solutions are compatible across multiple Business Notebook platforms enabling a lower total cost of ownership.

* HP/Kensington Cable Lock required (purchased separately)
** HP Advanced Docking Station only

Service and Support

HP Services offers limited 3- year, 1-year and 90-day warranty options depending on country;
1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. For HP Care Pack services see http://www.hp.com/go/lookuptool

For the school PIH the warranty is 3 Year next business onsite included.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details.

http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp

<u>Overview</u> <u>Standard Features</u> <u>Options</u> <u>Memory</u> <u>Storage</u> <u>Technical Specifications</u>

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Memory

667-MHz DDR2 SDRAM Two DIMM slots supporting dual channel memory DIMM sizes supported: 512 MB, 1024 MB, 2048, 4096 MB

Standard Memory

4096 MB (2048 MB x 2)

Optional Memory Upgrades

Support for up to 4096 MB of memory with the installation of optional DDR2 SDRAM memory kits. Both memory slots are user accessible. Please refer to the Hardware and Software Guide for installation procedures. Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

| Up to | Slot 1 | Slot 2 |
|---------|---------|---------|
| 1024 MB | 1024 MB | Empty |
| 1024 MB | 512 MB | 512 MB |
| 1536 MB | 1024 MB | 512 MB |
| 2048 MB | 1024 MB | 1024 MB |

4096 MB 2048 MB 2048 MB

NOTE: This chart does not represent all possible memory configurations. Due to the non-industry standard nature of some third-party memory modules, we strongly recommend using only HP branded memory modules to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Full availability of 8 GB of memory requires Windows Vista Business 64-bit or Linux. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

<u>Overview</u> <u>Standard Features</u> <u>Options</u> <u>Memory</u> <u>Storage</u> <u>Technical Specifications</u>

Storage

Optical Drive Support

Quantity Supported Drive Bay DVD+/-RW SuperMulti DL LightScribe Drive Fixed optical drive bay One Blu-Ray Disc DVD+/-RW SuperMulti DL Drive One Fixed optical drive bay

<u>Overview</u> <u>Standard Features</u> <u>Options</u> <u>Memory</u> <u>Storage</u> <u>Technical Specifications</u>

Technical Specifications

1.3 in (at front) x 15.5 in x 10.8 in Dimensions (HxWxD) System Unit 33 mm (at front) x 393 mm x 275 mm

Temperature

Starting from 7.5 lb (3.4 kg) Weight

NOTE: Height varies depending upon where on the notebook the measurement is made. Starting weight includes 8-cell battery, hard drive, 512-MB memory, 802.11 wireless communications module, Bluetooth, and optical drive. Weight varies by configuration and components.

Stand-Alone Power Requirements (AC Power) Nominal Operating Voltage Average Operating Power 12.5 W

> < 120 W (< 135 when configured with NVIDIA FX3600M) Max Operating Power

32° to 95° F (0° to 35° C) (not writing optical) Operating

Yes

Yes

Yes

 41° to 95° F (5° to 35° C) (writing optical) -4° to 140° F (-20° to 60° C) Non-operating

Relative Humidity Operating 10% to 90%, non-condensing

5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature Non-operating Operating 125 G, 2 ms, half-sine Shock

Non-operating 200 G, 2 ms, half-sine Random Vibration 0.75 grms Operating Non-operating 1.50 grms

CSA

FCC Compliance

-50 to 10,000 ft (-15.24 to 3,048 m) Operating (unpressurized) -50 to 40.000 ft (-1.5.24 to 12.192 m) Non-operating

Industry Standard Certifications UL Yes

> ICES Yes GS Yes Australia / NZ A-Tick Compliance Yes Japan VCCI Compliance Yes BSMI Yes CE Marking Compliance BNCI or BELLIS Yes CIT Yes

GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

UKRSERTCOMPUTER For accessibility information on HP products, please visit $\underline{\text{http://www.hp.com/accessibility}}.$

1.52 lb (0.69 kg) (adapter) 0.29 lb (0.13 kg) (power cord) HP 120W Smart AC Adapter Weight

Dimensions $6.65 \times 2.56 \times 1.50$ in (16.9 \times 6.5 \times 3.8 cm)

Operating Input Voltage 100 to 240 VAC Input Operating Input Current PFC Version

2.20 A at 90 VAC 1.10 A at 180 VAC

Non-PFC Version 47 to 63 Hz AC

Operating Frequency Range Efficiency 83% minimum at 115 VAC

120 W Output Output power DC Output Voltage 18.5 V

Operating Temperature 32° to 104° F (0° to 35° C) Environmental Design

Non-operating (storage) Temperature -4° to 149° F (-20° to 65° C) 0 to 10,000 ft (0 to 3,048 m)

Humidity 20% to 80% Storage Humidity 10% to 90%

EMI and Safety Certifications CE Mark: full compliance with LVD and EMC directives

Varidavide safety standards: IEC60950, EN60950, U60950, Class2, SEIV

Agency approvals: CULUS, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE, S-Mark, Australian Electric Permit, PSB, eK, BSMI, BNCI, KONCAR, GS, GOST, SASO, SABS, UKRSERTCOMPUTER

MTBF Over 200,000 hours at 25°C ambient condition

Dimensions $(H \times W \times I)$ 1.3 x 6.0 x 10.6 in (3.33 x 15.25 x 26.88 cm) Optional HP Ultra-Capacity Battery

> 1.77 lb (0.803 kg) Weight 12-cell Lithium-lon Cells/Type Energy Watt-hour Capacity 95Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C) 14° to 140° F (-10° to 60° C)

Operating (Discharging) Non-operating -4° to $140^{\circ}\,\text{F}$ (–20° to 60° C)

Battery Re-Charge Time Smart Adapter

> System ON 4 to 5 hours (depending on system power consumption)

Fuel Gauge When pressed, LEDs light indicating level of charge remaining on battery

Optional HP Extended Life Battery Dimensions $(H \times W \times I)$ $1.0 \times 3.9 \times 8.7$ in $(2.5 \times 10.0 \times 22.0$ cm)

> Weight 1.00 lb (0.455 kg) Cells/Type 8-cell Lithium-lon Energy Watt-hour Capacity

Operating (Charging) 32° to 113° F (0° to 45° C) Temperature Operating (Discharging) 14° to 140° F (-10° to 60° C)

Non-operating -4° to $140^{\circ}\,\text{F}$ (–20° to 60° C)

Battery Re-Charge Time System in OFF mode or Standby

> System ON 3 to 5 hours (depending on system power consumption) HP Fast Charge Charges the battery up to 90% within 90 minutes when system is OFF

52Wh

When pressed, LEDs light indicating level of charge remaining on battery Fuel Gauge

8-Cell (73WHr) Lithium-Ion battery Dimensions $(H \times W \times L)$ $0.8 \times 1.9 \times 10.6$ in $(2.0 \times 4.8 \times 27.0$ cm)

> 0.980 lb (0.445 kg) Weight Cells/Type 8-cell Lithium-Ion

Energy Watt-hour Capacity 73Wh 32° to 113° F (0° to 45° C) Operatina (Charaina) Temperature

> Operating (Discharging) 14° to 140° F (-10° to 60° C) -4° to 140° F (–20° to 60° C)

Battery Re-Charge Time System in OFF mode or Standby 2.5 hours

System ON $3\ {\sf to}\ 5\ {\sf hours}$ (depending on system power consumption)

HP Fast Charge Charges the battery up to 90% within 1.5 hours when system is OFF

14.5 x 9.0 in (36.7 x 22.9 cm) 17.0-inch WUXGA wide-viewing angle, anti-glare Active Area (W x H)

> Diagonal Size 17.0 in (43.2 cm) Surface Treatment Anti-glare 300:1 typical Contrast Ratio Refresh Rate 60 Hz 200 nit typical Brightness

Pixel Resolution Pitch 0.191 mm 1920 x 1200 Format Configuration RGB Stripe

Backlight CCFL 133 PPI

Viewing Angle ±60° Horizontal, ±50° Vertical (minimum)

Hard Drives

160-GB 7200 rpm SATA Drive Weight 0.25 lb (113 a)

Capacity 160 GB 0.37 in (9.5 mm) Height Width 2.75 in (70 mm) Interface ATA-7 / SATA 1.0a

Transfer Rate 100 MB/s (Drive Capability) Synchronous (maximum) Single Track

Seek Time (typical reads, including settling) 10 ms Average Maximum 18 ms

Rotational Speed 7200 rpm Logical Blocks 312.581.808

Operating Temperature 41° to 140° F (5° to 60° C) [case temp]

Features ATA Security

| DVD+/-RW SuperMulti DL LightScribe Drive | Access Times | Random | <175 ms CD |
|--|---|---|--|
| DYDTY KYY Superviolin DE Lightscribe Diffe | Access filles | Kanaom | <230 ms DVD |
| | Max Data Transfer Rate | 24X CD-ROM | 3,600 KB/s |
| | | 8X DVD | 10,800 KB/s |
| | | 24X CD-R | 3,600 KB/s |
| | | 16X CD-RW | 2,400 KB/s |
| | | 8X DVD+R | 10,800 KB/s |
| | | 4X DVD+RW | 5,400 KB/s |
| | | 8X DVD-R | 10,800 KB/s |
| | | 4X DVD-RW | 5,400 KB/s |
| | | 2.4X DVD+R(9) | 2,700 KB/s |
| | | 5X DVD-RAM | 6,750 KB/s |
| | Transfer Mode | Multiword DMA Mode | , , |
| | Interface | EIDE | |
| | Supported Media (read) | CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, RAM | |
| | Supported Media (write) | CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, LightScribe
8.5 GB | |
| | Max Media Capacity (read) | | |
| | Max Media Capacity (write) | 8.5 GB | |
| | Transport | Tray Loading | |
| | | | |
| DVD+/-RW SuperMulti DL Drive | Access Times | Random | <140 ms CD-ROM |
| Coponition De Dire | | | <160 ms DVD-ROM |
| | | | <300 ms BD-ROM |
| | Max Data Transfer Rate | 24X CD-ROM | 3,600 KB/s |
| | | 8X DVD-ROM | 10,800 KB/s |
| | | 8X CD-R | 1,200 KB/s |
| | | 8X CD-RW | 1,200 KB/s |
| | | 8X DVD+R | 10,800 KB/s |
| | | 4X DVD+RW | 5,400 KB/s |
| | | 8X DVD-R | 10,800 KB/s |
| | | 4X DVD-RW | 5,400 KB/s |
| | | 2.4X DVD+R(9) | 2,700 KB/s |
| | | 5X DVD-RAM | 6,750 KB/s |
| | | 1X BD-ROM | 4,500 KB/s |
| | | 1X BD-R | 4,500 KB/s |
| | | 1X BD-RE | 4,500 KB/s |
| | Transfer Mode | Multiword DMA Mode | 4,500 NB/ S |
| | | | |
| | Interface Supported Media (read) | EIDE CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (| |
| | | CD, CDEXTRA, Porfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW. DV
RAM, BD-ROM, BD-R, BD-RE | |
| | Supported Media (write) | CD-R, CD-RW, DVD+R, DVD+R(9), DV | /D+RW, DVD-R, DVD-R(9), DVD-RW, DVD-RAM, BD-R, BD-RE |
| | Max Media Capacity (read) | 50.0 GB | |
| | Max Media Capacity (write) | 50.0 GB | |
| | Transport | Tray Loading | |
| Security | | | |
| HP Fingerprint Sensor | Mobile Voltage | 3.0V–3.6V Single Supply | |
| | Operation | 000 | |
| | Operating Temperature | 32° – 158°F (0° – 70°C) | |
| | | | |
| | Current Consumption @ 3.3V | Less than 70 mA peak imaging and s Less than 25 mA hardware finger deli | |
| | Current Consumption @ 3.3V | Less than 25 mA hardware finger det
Advanced Power Management | |
| | Current Consumption @ 3.3V High-Rate Image Capture | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec | |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-4-2 Level 4 (±15KV) | |
| | Current Consumption @ 3.3V High-Rate Image Capture | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-4-2 Level 4 (±15KV)
192 x 16 Pixels | |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-4-2 Level 4 (±15KV) | |
| Audio | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-42 Level 4 (±15KV)
192 x 16 Pixels
9.7 mm x 0.81 mm | |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-4-2 Level 4 (±15KV)
192 x 16 Pixels
9.7 mm x 0.81 mm
500 ppi High-Resolution Images | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix | Less than 25 mA hardware finger det
Advanced Power Management
Up to 240 image frames /sec
IEC 61000-4-2 Level 4 (±15KV)
192 x 16 Pixels
9.7 mm x 0.81 mm
500 ppi High-Resolution Images | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-4-2 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute | ection |
| Audio
Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo | ection |
| Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo | ection |
| Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out Integrated Microphone | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo Yes | ection |
| Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out Integrated Microphone Frequency Response | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo Yes | ection |
| Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out Integrated Microphone Frequency Response Signal to Noise Ratio | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo Stereo Yes 20 Hz – 20 kHz > 85 dB | ection |
| Hardware | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out Integrated Microphone Frequency Response Signal to Noise Ratio Total Harmonic Distortion | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo Stereo Yes 20 Hz – 20 kHz > 85 dB 0.01% | ection |
| | Current Consumption @ 3.3V High-Rate Image Capture ESD Resistance Detection Matrix Implementation Touch-Sensitive Volume Controls Full Duplex Sound Blaster Pro compatible Microphone In Headphone/Line Out Integrated Microphone Frequency Response Signal to Noise Ratio Total Harmonic Distortion Noise Floor | Less than 25 mA hardware finger det Advanced Power Management Up to 240 image frames /sec IEC 61000-42 Level 4 (±15KV) 192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution Images ADI1981HD High Definition CODEC Volume up, volume down, and mute Yes Yes Stereo Stereo Yes 20 Hz – 20 kHz >85 dB 0.01% -110 dB | ection . |

Integrated Stereo Speakers

Power Rating 2 Watts Impedance

Communications

Integrated Intel Gigabit Network Connection (10/100/1000 NIC)

10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)
1000 Mbit/s operation (1000BASE-T; IEEE 802.3z and 802.3ab; IEEE 802.3 clauses 34-42)
Auto-Negotiation (Automatic Speed Selection)
Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s Ethernet Features

IEEE 802.1p QoS (Quality of Service) Support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

ACPI compliant - multiple power modes Power Management Situation-sensitive features reduce power consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))

Comprehensive diagnostic and configuration software suite

Intel Advanced Management Technology (iAMT)

PCI Express x1

Intel 82566MM Gigabit Network Connection NIC Device Driver Name

Microsoft Windows Vista Microsoft Windows XP Drivers Available

V.92 56K Data/Fax Modem

MDC 1.5 Daughtercard Form Factor Power Management Support APM Revision 1.2, ACPI

Data Mode Capabilities

UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Part 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian Approvals/ Certifications

ACA, CE Mark, Other Countries V.92 data

> V 8his V.80

V44, V.42bis, MNP5 (Compression) V.42 (LAPM, MNP2-4) (Error Correction)

Optional symbol rates: Asymmetric Symbol rates

Synchronous primary channel data signaling rates:

Automatic rate re-negotiation

V.32bis V.32 V.23 V.22bis V.22 V.21 Bell 212A Bell 103J

TIA/EIA-578-B (Class 1) Fax Mode Capabilities

T.30, T.4 (Group 3) V.17 V.17 V 27ter V.21 Channel 2 V.250 (Partial)

Command Set TIA-602

Identification: +GMI, +GMM, +GMR

Port control: +IPR, +ICF, +IFC, +IRR Modulation: +MS, +MR, +MA Error control: +ES, +ER, +EB, +ESR, +ETBM Data compression: +DS, +DR

V 251

Intel Wireless WiFi Link 4965AGN

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n (draft 1.02) Wi-Fi certified (802.11abg only)

Cisco Compatible Extensions Program compliant (802.11 abg only) with Microsoft Windows 2000 and XP (details at w.hp.com/go/notebooks/WLAN)

Tested with wireless access points from several major manufacturers (details at http://www.hp.com/go/notebooks/WLAN/draft-n)

2.4 GHz and 5 GHz Frequency Band

802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

Modulation Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of 128, 192, and 256 bits), 802.1x authentication types EAP-TILS, EAP-TILS, PEAP-GTC, PEAP-MSCHAP-V2, LEAP, EAP-FAST.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows 2000 and XP only.

Multinational support with frequency bands and channels compliant to local regulations. Sub-channels

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) Network Architecture Models

Roaming IEEE 802.11 compliant roaming between access points

Output Power (for $CKK)^2$ 15 dBm Output Power (for OFDM; power varies by data15 dBm

Power Consumption

Interoperability

Data Rates

Transmit: 2.3~Watts (average, with two spatial streams) Receive: 1.9~Watts (average with three receive chains) ldle mode³: 30~mW (average)

Radio off: 20 mW (max)

Power Management ACPI compliant power management 802.11 compliant power saving mode

Receiver Sensitivit√4 300 Mbps: -68 dBm, 54 Mbps: -74 dBm, 6 Mbps: -90 dBm

Antenna Connections 3 U.FL type connectors, 50 ohm nominal impedance

802.11 a – Typical 600 feet - Outdoor Open Area Ranae (@6 Mbps) 150 feet – Indoor, Office environment 802.11 b – Typical 1200 feet – Outdoor Open Area (@1 Mbps) 300 feet - Indoor, Office environment

802.11 g – Typical (@1 Mbps) 1200 feet – Outdoor Open Area 300 feet - Indoor, Office environment

Form Factor PCI-Express MiniCard Weight 0.013 lb (6 g)

0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm) Dimensions

Operating Voltage 3.3V +/- 9%, 1.5V +/- 5%

32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C) Operating Temperature Non-operating 10% to 90% (non-condensing) 5% to 90% (non-condensing) Operating Non-operating Humidity

0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m) Operating Non-operating Altitude

Microsoft Windows 2000 or XP Choice of Configuration Utility: Configuration Utility⁵

Microsoft Windows XP Wireless Network Connection Manager

Intel PROSet for Microsoft Windows 2000 or XP (required for Cisco Compatible Extensions support)

Microsoft Windows Vista

Microsoft Windows Vista Wireless Network Connection Manager

LED Activity

- LED Off Radio OFF; Solid LED On Radio ON Check latest software/driver release for updates on supported security features.
- Maximum output power may vary by country according to local regulations. In Power Save Polling mode and on battery power.

- Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
 WIAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows 2000 or XP. WIAN may also be compatible with certain third-party software supplicants

Bluetooth Profiles Supported (with Bluetooth for Windows 4.0 software)

Serial Port Profile (SPP)* Dial-Up Networking (DUN)*

Generic Object Exchange Profile (GOEP)

Object Push Profile (OPP)* File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP)* Personal Area Networking Profile (PAN)* Human Interface Device Profile (HID)*

FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Environmental Data

Eco-Label Certifications

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Federal Energy Management Program (FEMP)
- ECO declaration
- Korean Eco Label
- EPEAT Silver Rating

| System Configuration | The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook" | | | |
|------------------------------------|---|---------------|---------------|--|
| Energy Consumption | 115 VAC | 230 VAC | 100 VAC | |
| Normal Operation | 18.05 W | 19.49 W | 12.19 W | |
| Sleep (Energy Star low power mode) | 1.261 W | 1.281 W | 1.261 W | |
| Off | 1.563 W | 1.57 W | 1.563 W | |
| Heat Dissipation* | 115 VAC | 230 VAC | 100 VAC | |
| Normal Operation | 61.586 BTU/hr | 66.499 BTU/hr | 41.592 BTU/hr | |
| Sleep | 4.302 BTU/hr | 4.37 BTU/hr | 4.302 BTU/hr | |
| Off | 5.332 BTU/hr | 5.356 BTU/hr | 5.332 BTU/hr | |

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

| Declared Noise Emissions
(in accordance with ISO 7779 and ISO 9296) | Sound Power
(LWAd, bels) | Sound Pressure
(LpAm, decibels) |
|---|-----------------------------|------------------------------------|
| Idle | 3.1 | 25 |
| Operating mode (HDD) | 3.1 | 26 |

 $[\]ensuremath{^{\circ}}$ indicates the profile is also supported by Microsoft Windows XP SP2

Additional

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000 ppm by weight.

The battery type and chemistry used in the product is: CR2032 (coin cell), Lithium

8 cell rechargeable Lithium-Ion battery

This product is in compliance with the EU Restrictions of Hazardous Substances (RoHS) Directive -2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.

Keyboard complies with ISO standard: ISO 9995, EN 29241-4, and ISO/IEC 15412

Input devices of this product comply with ISO 9241, part 9.

Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% recycled materials (by wt.)

This product is greater than 92% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - Corrugated / Paper 2.25 lb (1019 g)
- Internal:
 - O EPE Foam 0.15 lb (70 g)
 - 0 LDPE Bag - 0.04 lb (19.44 g)
- The corrugated paper packaging materials contains at least 40% recycled content.

HP follows these auidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/ environment/supplychain/gen_specifications.html)

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)

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- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

End-of-life Management and Recycling

HP offers our customers several other options for handling their aging computers while also minimizing the impact on the environment—including product trade-in and leasing services-in addition to recycling services.

Please go to: https://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

Hewlett-Packard Corporate Environmental

For more information about HP's commitment to the environment:

Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Environment website

http://www.hp.com/environment Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

http://www.hp.com/hpinfo/globalcitizenship/ environment/operations/envmanagement.html

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